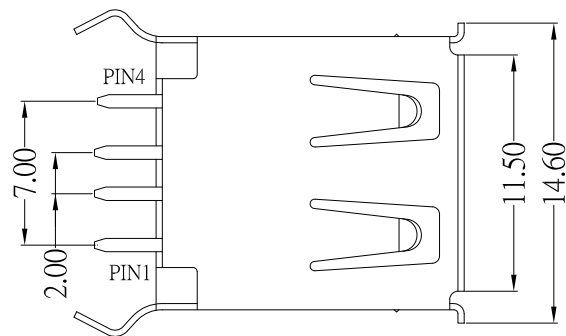




SUA-110V-x-x-S129

鍍層厚度 :

Blank : 1u"

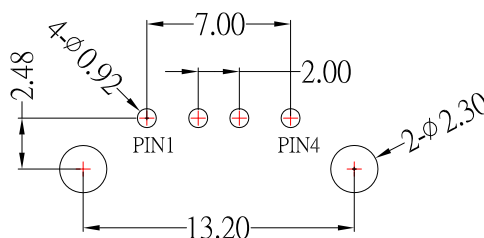
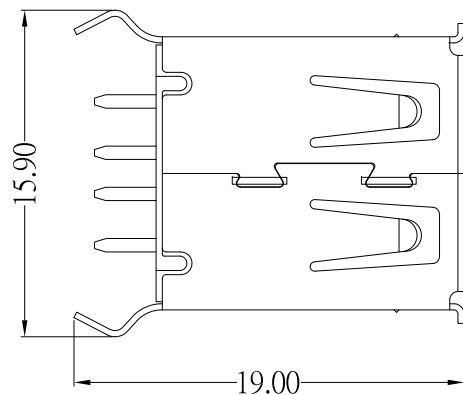
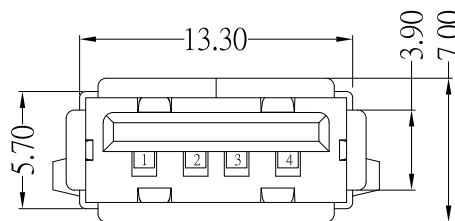
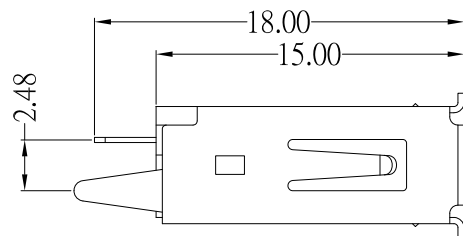
2 : 15u"

3 : 30u"

COLOR :

Black: B

White : W



P.C.B LAYOUT MOUNTING PATTERN

SPECIFICATIONS

1.MATERIAL:

- a.HOUSING:PBT
- b.CONTACT:BRASS
- c.SHEEL: BRASS

2.PLATING :

- a.CONTACT: Plated Gold in Mating Area ;
Tin Plated on Solder Balls ;
Nickel under plated overall
- b.PLATING: Nickel under Plated surface layer

3.ELECTRICAL:

- a.DIELECTRIC WITHSTANDING VOLTAGE: AC 500V
- b.INSULATION RESISTANCE: 1,000MΩ MIN
- c.CONTACT RESISTANCE: 30 mΩ MAX;

3.MECHANICAL:

- a.INSERTION FORCE: 3.57kg MAX
- b.WITHDRAWAL FORCE: 1.02kg MIN

				CONTACT 建倚科技股份有限公司 CONTACT TECHNOLOGY CORP.					
7	4	更新尺寸	Jack	061919	TOLERANCE UNLESS OTHERWISE STATED : Up to 5 ±0.2 Above 5 ~ 15 ±0.3 Above 15 ~ 30 ±0.4 Above 30 ~ 50 ±0.5 Angle ±0.3°	3RD. ANGEL'S		UNITS	MM
	3	新增PIN編號	Jack	062118					
	2	更新尺寸	Jack	050917					
	1	更新spec及材質	Jack	110813					
	ITEM NO.	DESCRIPTION	DRAWN	DATE					

DRAWN BY:	DATE	MAT'L		TITLE	CONNECTOR
Jack Lu	06/19/19				
CHECKED BY:	DATE	FINISH		MODLE	USB AF VERTICAL TYPE DIP
Jacky Chen	06/19/19				
APPROVED BY:	DATE	SCALE	1 : 1	DWG NO.	SUA-110V-x-x-S129
Tony Kao	06/19/19	SHEET NO.	1 of 1	PART NO.	SUA-110V-x-x-S129
				SIZE	A4
				VER	R4